

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-6.0	V
Collector Current	lc	-200	mA
Peak Collector Current	Ісм	-200	mA
Peak Base Current	I _{BM}	-100	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 6)	C	310	mW	
	(Note 7)	PD	350		
Thermal Desistance Junction to Ambient	(Note 6)	D	403	°C/W	
Thermal Resistance, Junction to Ambient	(Note 7)	R _{OJA}	357	°C/W	
Thermal Resistance, Junction to Leads	(Note 8)	R _{OJL}	350	°C/W	
Operating and Storage Temperature Range		T _J ,T _{STG}	-55 to +150	°C	

ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge—Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge—Machine Model	ESD MM	400	V	С

Notes: 6. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR4 PCB; the device is measured under still air conditions while operating in a steady-state.

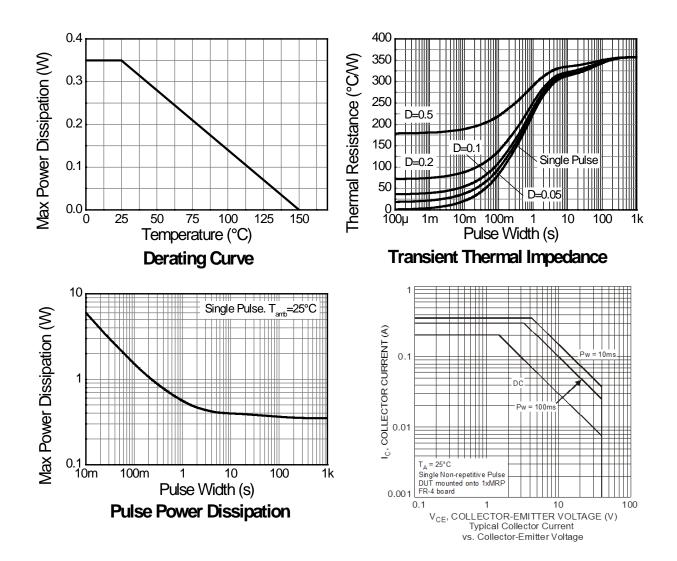
7. Same as Note 6 except the device is mounted on 15 mm × 15mm 1oz copper.

8. Thermal resistance from junction to solder-point (at the end of the leads).

9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





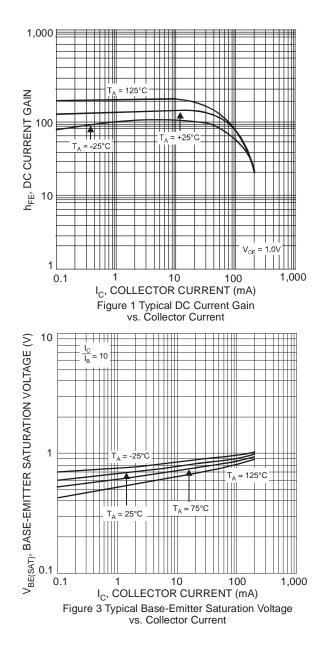
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

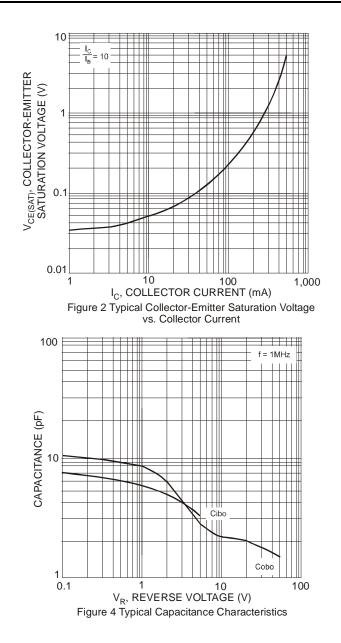
Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS					
Collector-Base Breakdown Voltage	BV _{CBO}	-40	_	V	$I_{\rm C} = -100 \mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-40		V	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	-6.0		V	$I_{\rm E} = -100 \mu A, I_{\rm C} = 0$
Collector Cutoff Current		_	-50	nA	$V_{CE} = -30V, V_{BE} = 3.0V$
	ICEV	_	-50	nA	$V_{CE} = -30V, V_{BE} = -0.25V$
Emitter-Base Cutoff Current	I _{EBO}	_	-50	nA	$V_{EB} = -5V$
ON CHARACTERISTICS (Note 10)					
		60	—		$I_{C} = -100 \mu A, V_{CE} = -1.0 V$
		80	—		$I_{C} = -1.0 \text{mA}, V_{CE} = -1.0 \text{V}$
DC Current Gain	h _{FE}	100	300	_	$I_{C} = -10 \text{mA}, V_{CE} = -1.0 \text{V}$
		60			$I_{C} = -50 \text{mA}, V_{CE} = -1.0 \text{V}$
		30			$I_{C} = -100 \text{mA}, V_{CE} = -1.0 \text{V}$
Collector-Emitter Saturation Voltage	V _{CE(sat)}		-0.25	V	$I_{C} = -10mA$, $I_{B} = -1.0mA$
			-0.40	v	$I_{C} = -50 \text{mA}, I_{B} = -5.0 \text{mA}$
Base-Emitter Saturation Voltage	Varia	Var 0.65 -0.85	V	$I_{C} = -10mA$, $I_{B} = -1.0mA$	
	V _{BE(sat)}	—	-0.95	v	$I_{C} = -50 \text{mA}, I_{B} = -5.0 \text{mA}$
SMALL SIGNAL CHARACTERISTICS					r
Output Capacitance	C _{obo}	_	4.5	pF	$V_{CB} = -5.0V, f = 1.0MHz, I_E = 0$
Input Capacitance	Cibo	_	10	pF	$V_{EB} = -0.5V, f = 1.0MHz, I_{C} = 0$
Input Impedance	h _{ie}	2.0	12	kΩ	
Voltage Feedback Ratio	h _{re}	0.1	10	× 10 ⁻⁴	$V_{CE} = 10V, I_{C} = 1.0mA,$
Small Signal Current Gain	h _{fe}	100	400	_	f = 1.0 kHz
Output Admittance	h _{oe}	3.0	60	μS	
Current Gain-Bandwidth Product	fT	250	—	MHz	$V_{CE} = -20V, I_{C} = -10mA,$ f = 100MHz
Noise Figure	NF		4.0	dB	$V_{CE} = -5.0V, I_C = -100\mu A,$ $R_S = 1.0k\Omega, f = 1.0kHz$
SWITCHING CHARACTERISTICS	1		1		,
Delay Time	t _d	_	35	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$
Rise Time	t _r		35	ns	$V_{BE(off)} = 0.5V, I_{B1} = -1.0mA$
Storage Time	ts	_	225	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$
Fall Time	-s t _f	_	75	ns	$I_{B1} = I_{B2} = -1.0$ mA

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

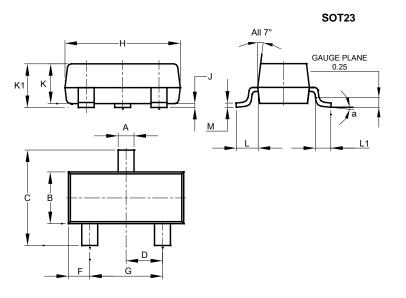






Package Outline Dimensions

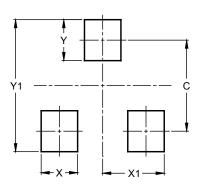
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
Κ	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
Μ	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

SOT23



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